



# Dual 90MHz 6-Bit Analog to Digital Converter with VCO

**Preliminary Information** 

DS4070 - 1.6 May 1996

The VP216 is a dual 90MHz 6-bit Analog to Digital Converter designed for use in consumer satellite receivers and decoders, video systems, multimedia and communications applications.

Operating from a single +5V supply, the VP216 includes an on-chip high bandwidth ADC driver amplifier, a 6-bit ADC, VCO or Ext. clock interface. The VP216 also has the necessary bias voltages for the reference resistor chain in the 'flash' architecture of the ADC.

#### FEATURES

- 90MHz Conversion Rate
- VCO or Ext. Clock Interface
- High Bandwidth ADC Driver Amplifier
- Internal ADC Reference
- TTL Data Outputs
- Single 5 Volt Supply
- Dual ADC System for good channel matching

### APPLICATIONS

- Satellite Decoders
- Multimedia
- Communications

# **ORDERING INFORMATION**

VP216A CG HP1S (Commercial - 44 pin PLCC)

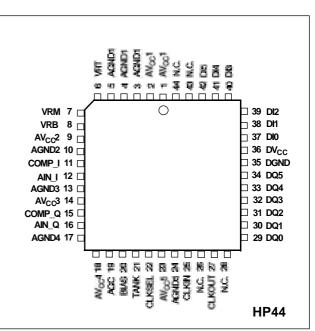


Fig.1 Pin connections - top view

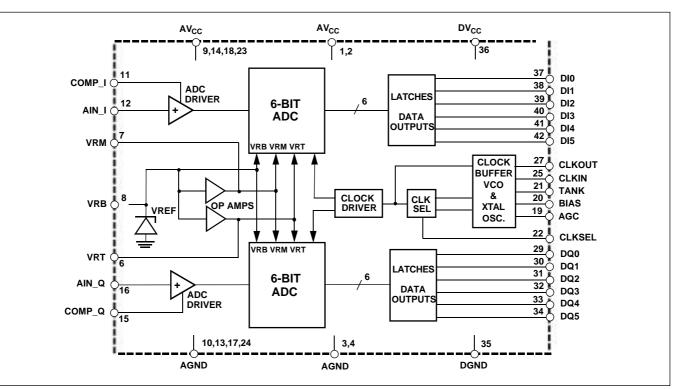


Fig.2 System block diagram

# **VP216**

# **ABSOLUTE MAXIMUM RATINGS**

DC supply voltage (V <sub>CC</sub> )	-0.3 to +7V
Analog input voltage (AIN)	-0.3 to V <sub>CC</sub> +0.3V
Digital inputs (CLKSEL, MSBSEL)	V <sub>CC</sub>
Digital output current (loh, lol, lsc)	-20 to +20mÅ
Ambient operating temperature (Tamb	) 0°C to +70°C
Storage temperature (Tstorage)	-55°C to +125°C

# **THERMAL CHARACTERISTICS**

THERMAL RESISTANCES	
Junction to case( jc)	19°C/W
Junction to ambient( jA)	55°C/W

ELECTRICAL CHARACTERISTICS Test conditions (unless otherwise stated) Tamb = 25°C, AV<sub>CC</sub> = DV<sub>CC</sub> = +5V, full temperature range = 0°C to +70°C DC CHARACTERISTICS All specifications apply to either of the two ADCs

Characteristic	Symbol	Temp.	Test Level	Min.	Value Typ.	Max.	Units	Conditions
Resolution	-	-	-	6	-	-	Bits	
Static performance								
Differential non-linearity	DNL	+25°C	4	-	-	±0.5	LSB	
		Full	4	-	_	±0.5	LSB	
Integral non-linearity	INL	+25°C	4	-	-	±0.5	LSB	
		Full	4	-	_	±0.5	LSB	
Missing codes		Full	4		Guaranteed			
Power supply								
Analog supply voltage	AV <sub>CC</sub>	Full	4	4.75	5.0	5.25	V	
Digital supply voltage	DV <sub>CC</sub>	Full	4	4.75	5.0	5.25	v	
Analog supply current	Alcc	+25°C	1	60	72	85	mA	
Analog supply current	AICC	Full	4	-	-	-	mA	
Digital supply current	DI <sub>CC</sub>	+25°C	1	15	23	30	mA	
Digital supply current	DICC	Full	4	15	23	- 50	mA	
Dower dissinction	Р	+25°C	4	-	-			
Power dissipation	P	Full	4	375	475	575 -	mW mW	
Analog input								
Input range	V <sub>in</sub>	Full	5	_	1.0	_	V	Pk to Pk
Input resistance	v in R <sub>in</sub>	+25°C	1	4.5k	5.75k	7.5k	v	TRUTR
Input capacitance		+25°C +25°C	5	4.JK	3.0	7.5K -	pF	
Gain matching	C <sub>in</sub>	+25°C +25°C	1	-	- 3.0	0.25	dB	
	A <sub>VH</sub>	+25°C +25°C	4	-		0.25		
Input -3dB bandwidth	F3dB			-	200	-	MHz	
Ain input voltage	Aindc	+25°C	1	3.6	3.85	4.1	V	
Comp output	Vcomp	+25°C	1	1.6	1.8	2.0	V	
CLKIN								
Input voltage high	V <sub>ih</sub>	+25°C	1	2.0	-	-	V	
		Full	4	-	-	-	V	
Input voltage low	V <sub>il</sub>	+25°C	1	-	-	0.8	V	
		Full	4	-	-	-	V	
Input current high	l <sub>ih</sub>	+25°C	1	-	-	1	μA	DV <sub>CC</sub> = 5.25V
		Full	4	-	-	-		$V_{in} = 2.7V$
Input current low	l <sub>il</sub>	+25°C	1	-0.2	_	-0.5	mA	DV <sub>CC</sub> = 5.25V
input ourient low	'11	Full	4	-	-	-	110.0	$V_{in} = 0.4V$
TTL digital outputs								
	V	12500	4	24		20	V	$D_{1} = 475_{1}$
Output voltage high	V <sub>oh</sub>	+25°C	1	2.4	-	3.0	V	$DV_{CC} = 4.75V$
		Full	4	-	-	-	V	$I_{oh} = -400 \mu A$
Output voltage low	V <sub>ol</sub>	+25°C	1	-	-	0.4	V	$DV_{CC} = 4.75V$
		Full	4	-	-	-	V	I <sub>ol</sub> = 1mA
Output current high	I <sub>oh</sub>	+25°C	1	-	-	-400	μA	$DV_{CC} = 4.75V$
	011	Full	4	-	-	-	· -	
Output current low	I <sub>ol</sub>	+25°C	1	-	-	1	mA	$DV_{CC} = 4.75V$
	.01	Full	4	-	_		-	
		i uli	+	-	-	-	-	

# **DC CHARACTERISTICS (cont.)**

Characteristic	Symbol	Temp.	Test Level	Min.	Value Typ.	Max.	Units	Conditions
CLKSEL								
Input voltage high	V <sub>ih</sub>	+25°C	1	2.0	-	-	V	
		Full	4	-	-	-	V	
Input voltage low	V <sub>il</sub>	+25°C	1	-	-	0.8	V	
		Full	4	-	-	-	V	
Input current high	l <sub>ih</sub>	+25°C	1	-	-	1.0	μA	DV <sub>CC</sub> = 5.25V
		Full	4	-	-	-		$V_{ih} = 2.7V$
Input current low	l <sub>il</sub>	+25°C	1	-50	-100	-150	μA	$DV_{CC} = 5.25V$
		Full	4	-	-	-		$V_{il} = 0.4V$
VCO								
Input capacitance	C <sub>tank</sub>	+25°C	5	-	2.0	-	pF	
Bias voltage	V <sub>bias</sub>	+25°C	1	1.4	1.6	1.8	V	
AGC voltage	V <sub>agc</sub>	+25°C	1	1.3	1.65	1.7	V	
Reference voltage								
REF 2.5	VRB	+25°C	1	2.374	2.525	2.677	V	ר <b>ו</b>
REF 3.0	VRM	+25°C	1	2.848	3.03	3.212	V	ho load
REF 3.5	VRT	+25°C	1	3.323	3.55	3.747	V	ر <sub>ا</sub>

### **AC CHARACTERISTICS**

Characteristic	Symbol	Temp.	Test Level	Min.	Value Typ.	Max.	Units	Conditions
Switching performance								
Clock high pulse width	T <sub>pw</sub> 1	+25°C	4	30	50	70	%	Cload=10pF
Clock low pulse width	T <sub>pw</sub> 0	+25°C	4	30	50	70	%	Cload=10pF
Max. conversion rate	F <sub>max</sub>	+25°C	1	90	-	-	MHz	
Data setup time	T <sub>su</sub>	Full	4	8	10	-	ns	
Data hold time	Th	Full	4	2	4	-	ns	
Aperture delay	T <sub>ad</sub>	+25°C	4	2	3	4	ns	
Aperture delay matching	T <sub>ad</sub>	+25°C	4	-	0.2	0.5	ns	
Aperture jitter	T <sub>aj</sub>	+25°C	4	10	25	50	ps rms	
Dynamic performance								
Differential non-linearity	DNL	+25°C	1	-0.95	-	+1.2	LSB	A <sub>IN</sub> =15MHz
Integral non-linearity	INL	+25°C	1	-	-	±1	LSB	A <sub>IN</sub> =15MHz
Signal to noise ratio	SNR	+25°C	1	31.8	-	-	dB	
Total harmonic distortion	THD	+25°C	4	40	-	-	dBc	
Effective No. of bits	ENOB	+25°C	1	5.0	5.5	-	bits	A <sub>IN</sub> =15MHz
Crosstalk rejection	CTR	+25°C	5	-	50	-	dBc	
Input offset	V <sub>os</sub>	+25°C	1	-	±0.5	±1	LSB	A <sub>IN</sub> =15MHz
Error rate	BER	+25°C	5	-	10e <sup>-8</sup>	-		

NOTES

1. An input voltage of 0.0 volts ±0.5 LSB should nominally correspond to the '011111' to '100000'B transition edge.

# **TEST LEVELS**

Level 1 - 100% production tested.

- Level 2 100% production tested at 25°C and sample tested at specified temperatures.
- Level 3 Sample tested only.
- Level 4 Parameter is guaranteed by design and characterisation testing.
- Level 5 Parameter is typical value only.

# VP216

# PIN DESCRIPTIONS - 44 Pin J-lead PLCC package

Pin	Name	Description
1	AV <sub>CC</sub> 1	Analog voltage supply for the 6-bit ADCs
2	AV <sub>CC</sub> 1	Analog voltage supply for the 6-bit ADCs
3	AGND1	Analog ground
4	AGND1	Analog ground
5	AGND1	Analog ground
6	VRT	3.5V reference voltage - ladder top
7	VRM	Reference voltage - ladder middle
8	VRB	2.5V reference voltage - ladder bottom
9	AV <sub>CC</sub> 2	Analog voltage supply for the reference bias circuits
10	AGND2	Analog ground
11	COMP-I	Capacitor compensation - I channel
12	AIN-I	Analog signal input - I channel
13	AGND3	Analog ground for the I channel buffer amplifier
14	AV <sub>CC</sub> 3	Analog voltage supply for the I channel buffer amplifier
15	COMP-Q	Capacitor compensation - Q channel
16	AIN-Q	Analog signal input - Q channel
17	AGND4	Analog ground
18	AV <sub>CC</sub> 4	Analog voltage supply for the Q channel buffer amplifier
19	AGC	AGC control voltage
20	BIAS	Input bias voltage
21	TANK	Tank circuit connection
22	CLKSEL	Clock select - VCO or external clock
23	AV <sub>CC</sub> 5	Analog voltage supply for the VCO
24	AGND5	Analog ground
25	CLKIN	Clock input positive
26	N.C.	Not connected
27	CLKOUT	Clock output positive
28	N.C.	Not connected
29	DQ0	Digital TTL output - LSB -Q channel
30	DQ1	
31	DQ2	
32	DQ3	
33	DQ3 DQ4	
33 34	DQ4 DQ5	Digital TTL output - MSB - Q channel
34 35	DGS	Digital ground
36	DGND	Digital voltage supply
30	DV <sub>CC</sub>	Digital TTL output - LSB - I channel
37 38	DI0 DI1	
38 39	DI1 DI2	
39 40	DI2 DI3	
	DI3 DI4	
41	DI4 DI5	Digital TTL output MSP Labornal
42		Digital TTL output - MSB - I channel Not connected
43	N.C.	
44	N.C.	Not connected

Table 1: Pin descriptions

#### **Device Description**

The VP216 is a dual 90MHz 6-bit ADC system, (see Fig.2). Included on chip is a high bandwidth ADC driver amplifier, a 6-bit analog to digital converter, latches and TTL data outputs. The VP216 also has the necessary bias voltages for the reference resistor chain in the 'flash' architecture of the ADC and has an optional VCO or external oscillator interface.

#### Analog Input

The analog inputs, (AIN\_I,Q) are A.C. coupled into the non-inverting ADC driver amplifiers, which provide the necessary bandwidth, gain, offset and low impedance required to drive the ADC. The amplifier has been designed so that an input of 0 volts will produce an output level equal to the voltage present at the middle of the ADC resistor chain, (VRM = 3V typ.). This is achieved by an internal feedback loop within each amplifier which compares the amplifier output with VRM, (see Fig.3). This voltage will produce a transition binary code of 011111 to 100000 at the output of the ADC.

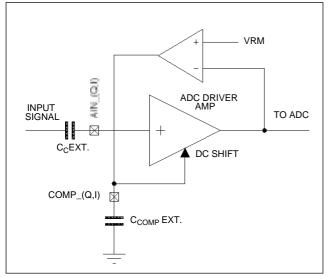


Fig.3 DC offset internal feedback loop.

#### **Reference Voltage**

An on chip band gap voltage reference circuit combined with two op-amps provides all the necessary bias voltages for the ADC reference resistor chain, (VRB), (VRM) and (VRT). VRB, VRM and VRT have been brought out to pins 8, 7 and 6 respectively and should be decoupled with 100nF capacitors close to the package pins.

#### **Digital Interface**

The TTL data output pins, (DI0-DI5) and (DQ0-DQ5) have been optimized to interface with devices in close proximity to the VP216 and are designed to provide satisfactory logic levels at speeds up to 90MHz into a fanout of one and a total load capacitance of 10pF. All data outputs should have approximately equivalent loading to ensure proper setup and hold timing. For capacitive loads in excess of 10pF, output buffers are recommended.

#### **Clock Interface**

The VP216 clock interface allows the ADC to be clocked in a number of ways. With the CLKSEL pin tied low the on chip VCO is selected. With the CLKSEL pin tied high the external TTL clock input is selected.

CLKSEL	Clock Source		
1	External Clock		
0	VCO		
Toble 2			

Table 2

The clock signal to the ADC synchronizes the sampling, conversion and output stages of the device as shown in the timing diagram (see Fig.4). The output of the ADC driver amp is sampled when the comparator array is latched after a rising edge of the input clock. Latched data is then presented to the TTL data outputs and latched on the falling edge of the input clock. The clock interface also provides a TTL clock output on pin 27. This output is limited to driving capacitive loads of 10pF. Output buffers are recommended for loads in excess of 10pF.

	Input Voltage			
Code	1 Volt Full Scale 16mV = 1LSB	Binary		
00	Least +Ve Valid Input	000000		
01	•	000001		
•	•	•		
31	•	011111		
32	•	100000		
33	•	100001		
•	•	•		
62	•	111110		
63	Most +Ve Valid Input	111111		

Table 3: Output coding

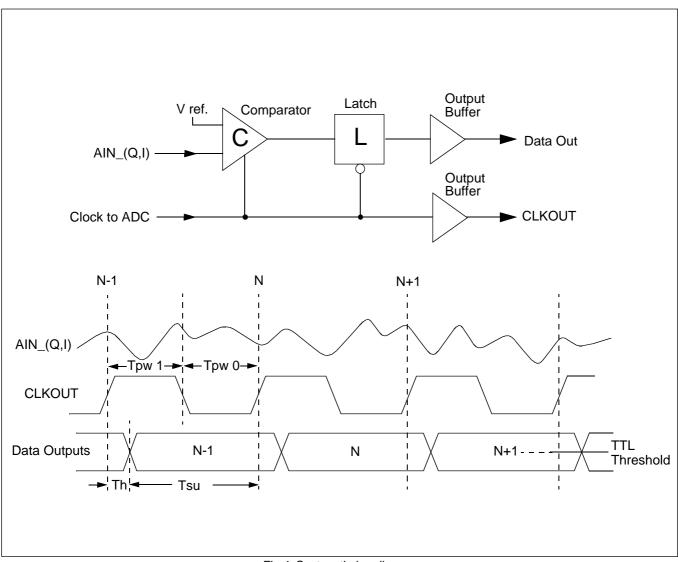


Fig.4 System timing diagram

# **ELECTRICAL CHARACTERISTICS DEFINITIONS**

#### **Analog Bandwidth**

The analog input frequency at which the spectral power of the fundamental frequency, as determined by FFT analysis is reduced by 3dB.

#### **Aperture Delay**

The delay between the rising edge of the 90MHz clock signal and the instant the analog input signal is sampled.

# **Aperture Jitter**

The sample to sample variation in aperture delay.

#### Bit Error Rate (BER)

The number of spurious code errors produced for any given input sinewave frequency at a given clock frequency. In this case it is the number of codes occurring outside the histogram cusp for a 1/2 FS sinewave.

#### Data Outputs, Set-up and Hold Time

Data output timings are measured from 2.4V and 0.4V to the 1.4V threshold on the rising edge of the output clock.

#### **Differential Non-linearity**

The deviation in any code width from an ideal 1 LSB step.

#### Effective Number of Bits (ENOB)

This is a measure of a device's dynamic performance and may be obtained from the SNR or from a sine wave curve test fit according to the following expressions:

ENOB = SNR-1.76/6.02 or

ENOB = N-log2[rms error (actual)/rms error (ideal)]

where N is the conversion resolution and the actual rms error is the deviation from an ideal sine wave, calculated from the converter outputs with a sine wave input.

#### Integral Non-linearity (INL)

The deviation of the centre of each code from a reference line which has been determined by a least squares curve fit.

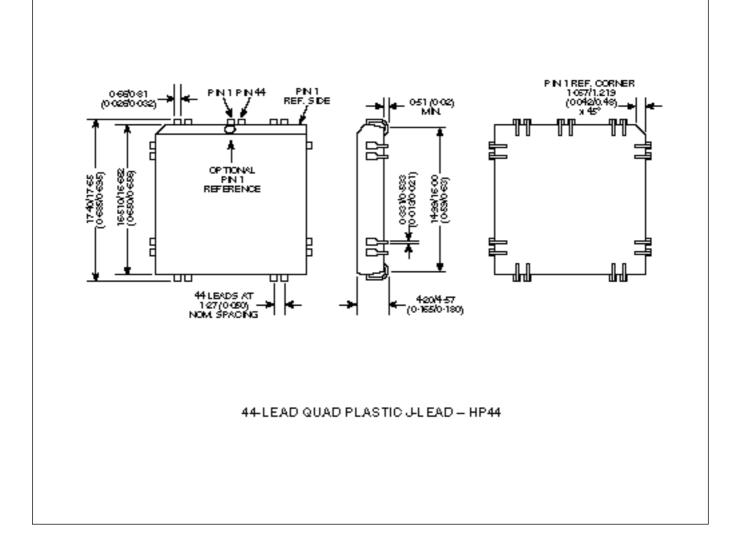
#### Signal-to-Noise Ratio (SNR)

The ratio of the rms signal amplitude to the rms value of 'noise' which is defined as the sum of all other spectral components, including the harmonics, but excluding D.C. with a full-scale analog input signal.

NOTES

## **PACKAGE DETAILS**

Dimensions are shown thus: mm (in). For further package information, please contact your local Customer Service Centre.



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